



Dimensions in inches and (millimeters)

FEATURES

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ Ideal for printed circuit boards
- ◆ Low reverse leakage
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed:
260°C/10 seconds, 0.375" (9.5mm) lead length,
5 lbs. (2.3kg) tension

MECHANICAL DATA**Case:** Molded plastic body**Terminals:** Plated leads solderable per MIL-STD-750, Method 2026**Polarity:** Polarity symbols marked on case**Mounting Position:** Any**Weight:** 0.05 ounce, 1.42 grams**MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS**

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

	SYMBOLS	2W005	2W01	2W02	2W04	2W06	2W08	2W10	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	VOLTS
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	VOLTS
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	VOLTS
Maximum average forward output rectified current at $T_A=50^\circ\text{C}$ (Note 2)	I_{AV}	2.0							Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	50.0							Amps
Rating for Fusing ($t < 8.3\text{ms}$)	I^2t	10							A^2s
Maximum instantaneous forward voltage drop per bridge element at 1.0A	V_F	1.0							Volts
Maximum DC reverse current $T_A=25^\circ\text{C}$ at rated DC blocking voltage $T_A=100^\circ\text{C}$	I_R	10							mA
		0.5							mA
Typical Junction Capacitance (Note 1)	C_J	15							pF
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	40							$^\circ\text{C}/\text{W}$
Operating junction temperature range	T_J	-55 to +125							$^\circ\text{C}$
storage temperature range	T_{STG}	-55 to +150							$^\circ\text{C}$

NOTES:

1. Measured at 1.0 MHz and applied reverse voltage of 4.0 Volts.

2. Unit mounted on P.C. board with 0.22" x 0.22" (5.5x5.5mm) copper pads, 0.375" (9.5mm) lead length.

